

**Features**

- Advanced Shield Gate Trench technology
- Super Low Gate Charge
- High-Speed Switching
- 100% EAS Guaranteed
- Green Device Available

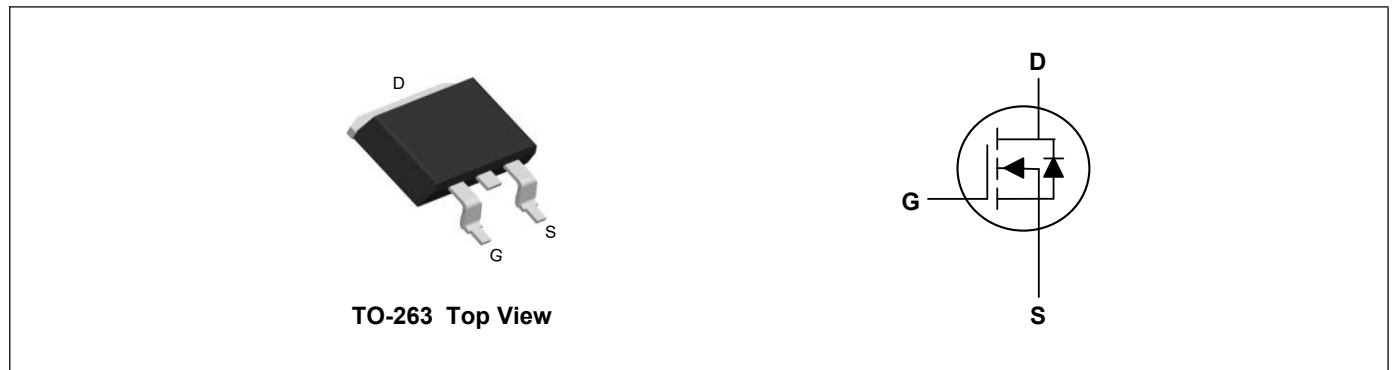
**Applications**

- High Frequency Point-of-Load, Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch

**Product Summary**



$V_{DS}$	85	V
$I_D$	120	A
$R_{DS(ON)}$ (at $V_{GS}=10V$ )	5.4	m $\Omega$



**Absolute Maximum Ratings( $T_C=25^\circ C$ , unless otherwise noted)**

Parameter	Symbol	Rating	Units
Drain-Source Voltage	$V_{DS}$	85	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>1</sup>	$I_D$	120	A
Continuous Drain Current <sup>1</sup>	$I_D$	65	A
	$T_C=100^\circ C$		
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	360	A
Single Pulse Avalanche Energy <sup>3</sup>	$E_{AS}$	780	mJ
Total Power Dissipation	$P_D$	180	W
Storage Temperature Range	$T_{STG}$	-55 to 175	$^\circ C$
Operating Junction Temperature Range	$T_J$	-55 to 175	$^\circ C$

**Thermal Characteristics**

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Ambient <sup>1</sup>	$R_{\theta JA}$	---	28	$^\circ C/W$
Thermal Resistance Junction-Case <sup>1</sup>	$R_{\theta JC}$	---	0.83	$^\circ C/W$

**Electrical Characteristics ( $T_J=25^{\circ}\text{C}$ , unless otherwise noted)**

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	85	---	---	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=50A$	---	4.4	5.4	m $\Omega$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2	3	4	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=80V, V_{GS}=0V$	---	---	1	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	nA
Gate Resistance	$R_g$	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$	---	2	---	$\Omega$
Total Gate Charge	$Q_g$	$V_{DS}=40V, V_{GS}=10V, I_D=50A$	---	44	---	nC
Gate-Source Charge	$Q_{gs}$		---	14	---	
Gate-Drain Charge	$Q_{gd}$		---	11	---	
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=40V, V_{GS}=10V, R_G=2.7\Omega, I_D=10A$	---	14	---	ns
Rise Time	$T_r$		---	23	---	
Turn-Off Delay Time	$T_{d(off)}$		---	36	---	
Fall Time	$T_f$		---	16	---	
Input Capacitance	$C_{iss}$	$V_{DS}=42.5V, V_{GS}=0V, f=1\text{MHz}$	---	3900	---	pF
Output Capacitance	$C_{oss}$		---	650	---	
Reverse Transfer Capacitance	$C_{rss}$		---	20	---	

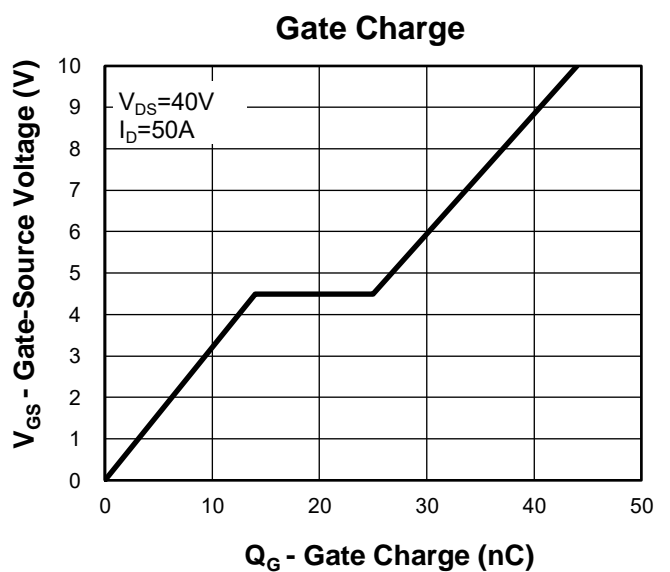
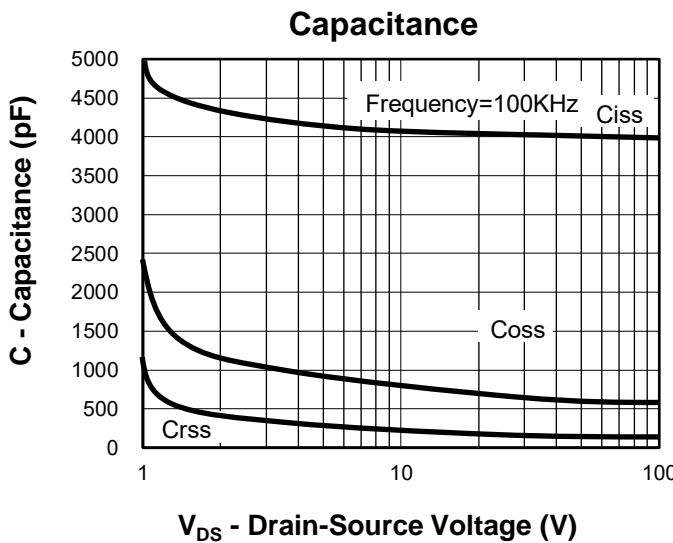
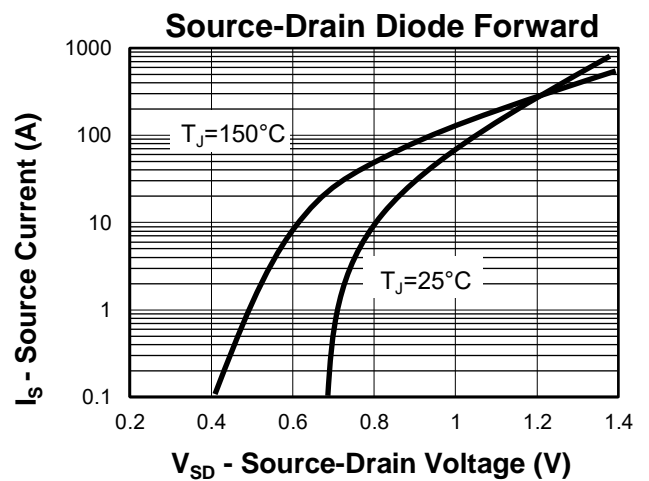
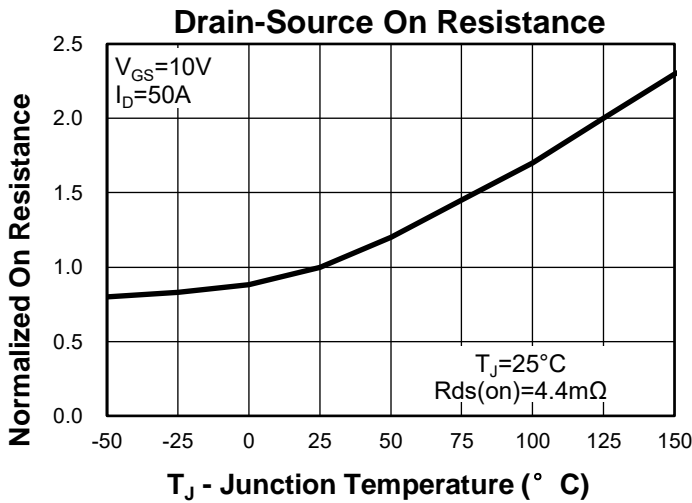
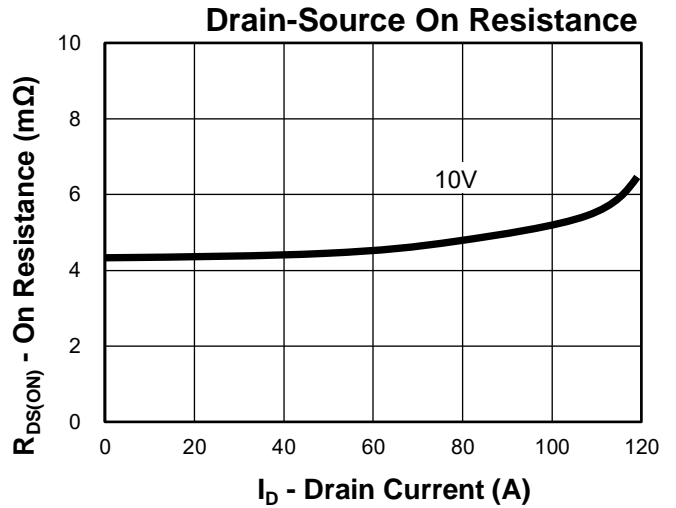
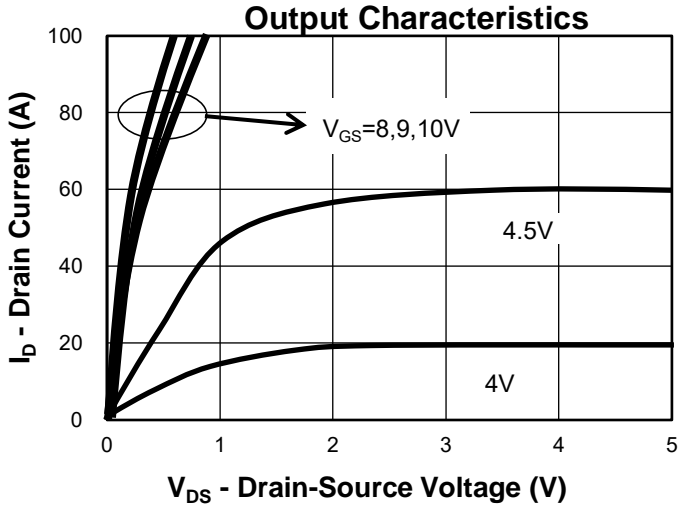
**Drain-Source Diode Characteristics**

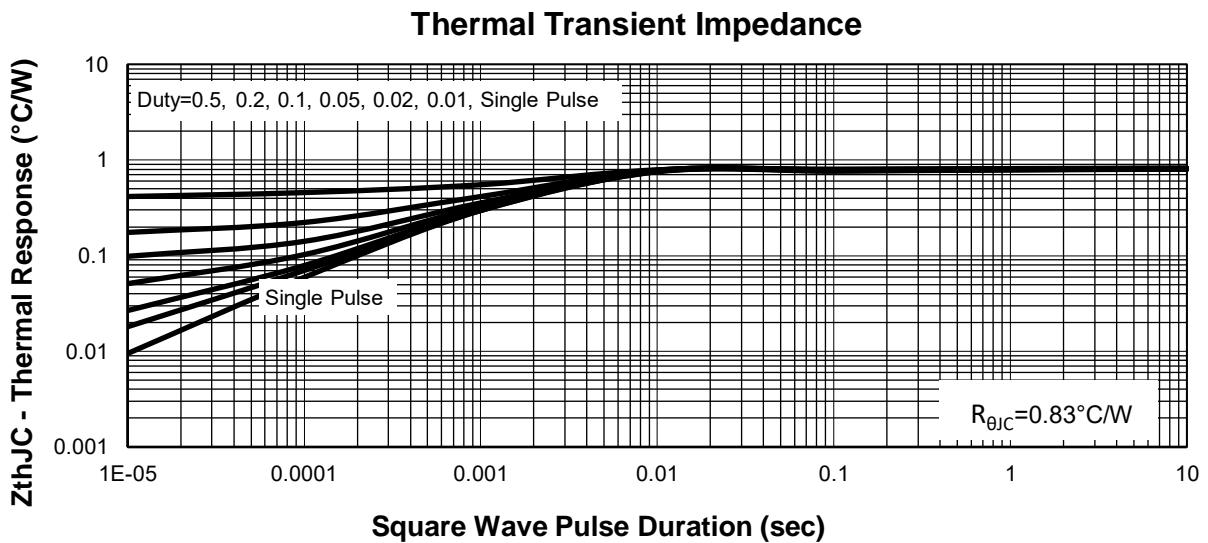
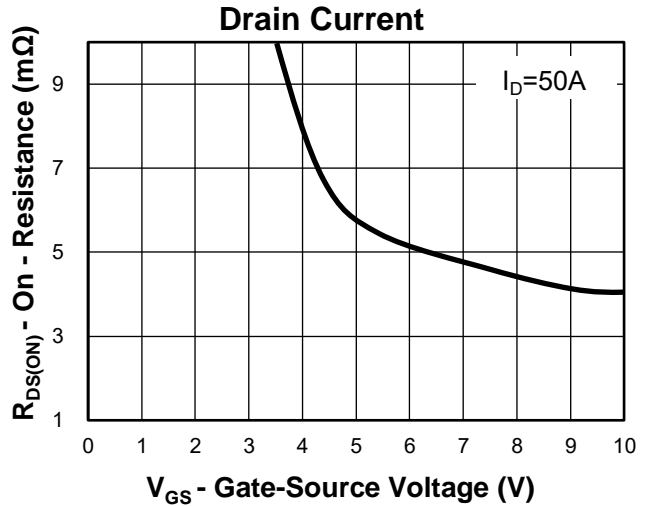
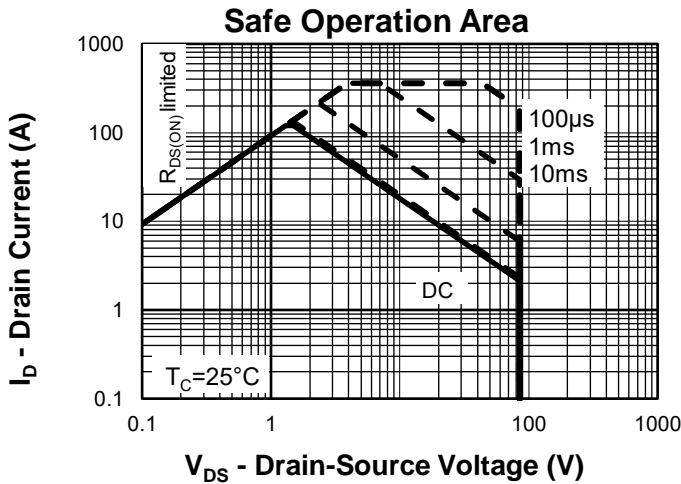
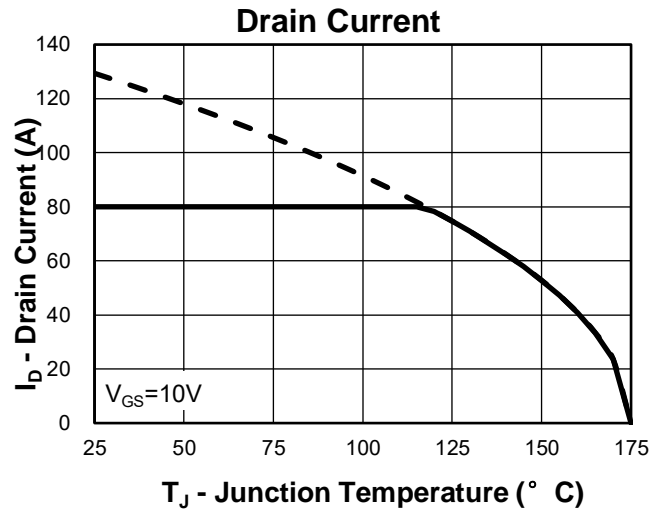
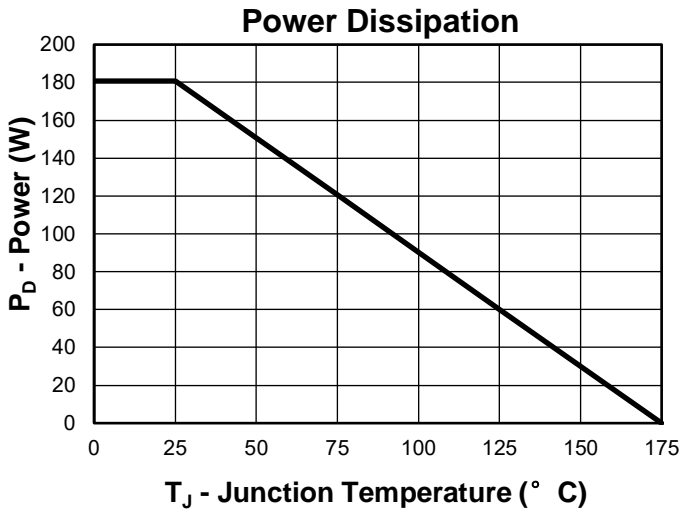
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Continuous Source Current <sup>1</sup>	$I_S$		---	---	120	A
Diode Forward Voltage <sup>2</sup>	$V_{SD}$	$V_{GS}=0V, I_S=10A, T_J=25^{\circ}\text{C}$	---	---	1.2	V
Reverse Recovery Time	$t_{rr}$	$I_S=50A$	---	38	---	nS
Reverse Recovery Charge	$Q_{rr}$	$di/dt=100A/\mu s, T_J=25^{\circ}\text{C}$	---	45	---	nC

**Note:**

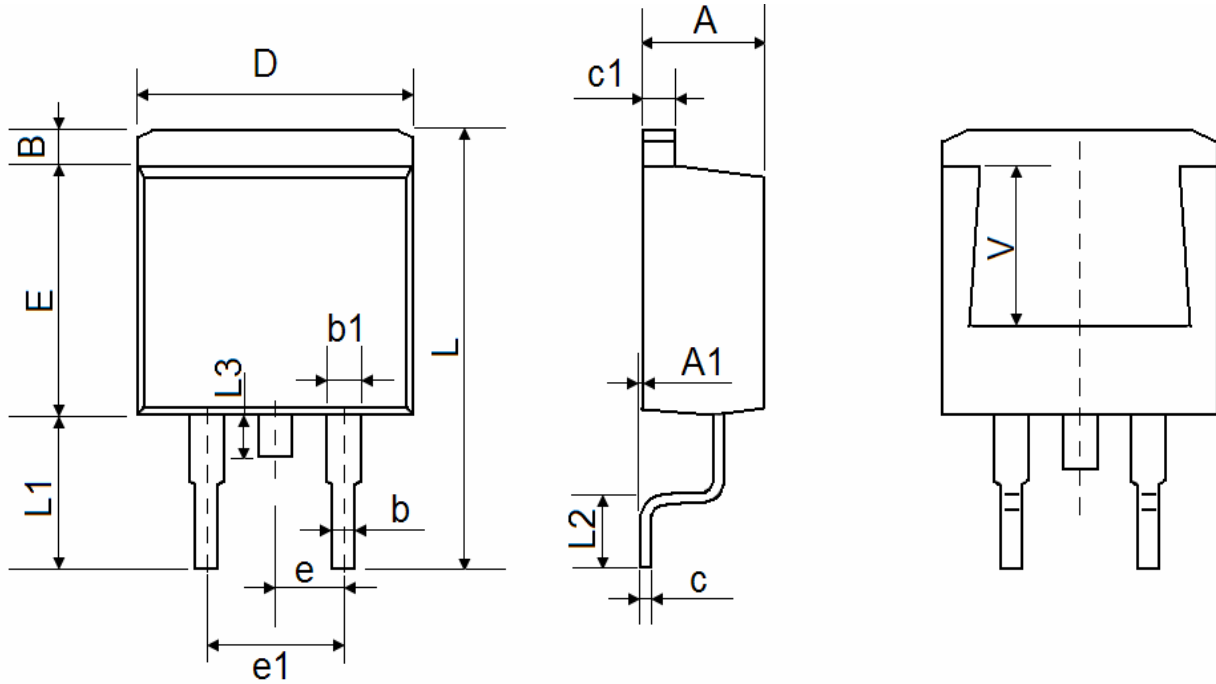
- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is  $V_{DD}=48V, R_G=50\Omega$

**Typical Characteristics**





**TO-263 Package Outline Dimensions**



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
<b>A</b>	4.40	4.55	4.70	<b>A1</b>	0.00	0.07	0.15
<b>B</b>	1.00	1.20	1.40	<b>b</b>	0.65	0.80	0.95
<b>b1</b>	1.10	1.15	1.37	<b>c</b>	0.30	0.40	0.53
<b>c1</b>	1.10	1.25	1.37	<b>D</b>	9.80	10.00	10.40
<b>E</b>	8.50	8.80	9.20	<b>e</b>	2.54 REF		
<b>e1</b>	4.90	5.10	5.40	<b>L</b>	14.80	15.20	15.70
<b>L1</b>	5.00	5.25	5.60	<b>L2</b>	2.05	2.45	2.80
<b>L3</b>	1.20	1.50	1.80	<b>V</b>	5.60 REF		